



SANYO Semiconductors

DATA SHEET

An ON Semiconductor Company

30C02MH — Low-Frequency General-Purpose Amplifier Applications

NPN Epitaxial Planar Silicon Transistor

Applications

- Low-frequency Amplifier, high-speed switching, small motor drive

Features

- Large current capacity
- Low collector-to-emitter saturation voltage (resistance) : $R_{CE(sat)}$ typ=330m Ω [$I_C=0.7A$, $I_B=35mA$]
- Ultrasmall package facilitates miniaturization in end products
- Small ON-resistance (R_{on})
- Halogen free compliance

Specifications

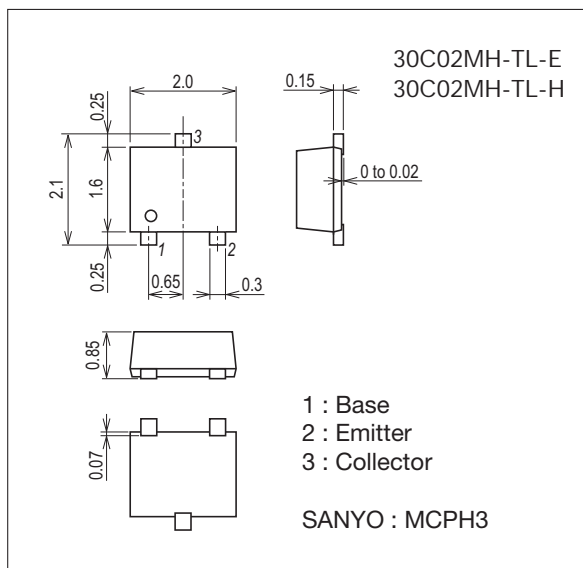
Absolute Maximum Ratings at $T_a=25^\circ C$

Parameter	Symbol	Conditions	Ratings	Unit
Collector-to-Base Voltage	V_{CB0}		40	V
Collector-to-Emitter Voltage	V_{CE0}		30	V
Emitter-to-Base Voltage	V_{EB0}		5	V
Collector Current	I_C		700	mA
Collector Current (Pulse)	I_{CP}		1.4	A
Collector Dissipation	P_C	When mounted on ceramic substrate (600mm ² x0.8mm)	600	mW
Junction Temperature	T_J		150	$^\circ C$
Storage Temperature	T_{stg}		-55 to +150	$^\circ C$

Package Dimensions

unit : mm (typ)

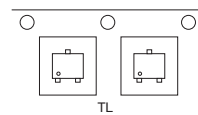
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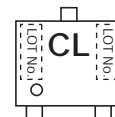
Product & Package Information

- Package : MCPH3
- JEITA, JEDEC : SC-70, SOT-323
- Minimum Packing Quantity : 3,000 pcs./reel

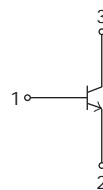
Packing Type : TL



Marking



Electrical Connection



SANYO Semiconductor Co., Ltd.

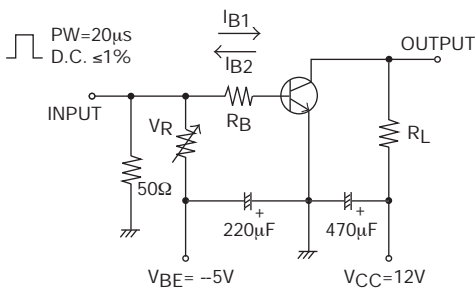
<http://semicon.sanyo.com/en/network>

30C02MH

Electrical Characteristics at $T_a=25^\circ\text{C}$

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Collector Cutoff Current	I_{CBO}	$V_{CB}=30\text{V}, I_E=0\text{A}$			100	nA
Emitter Cutoff Current	I_{EBO}	$V_{EB}=4\text{V}, I_C=0\text{A}$			100	nA
DC Current Gain	h_{FE}	$V_{CE}=2\text{V}, I_C=50\text{mA}$	300		800	
Gain-Bandwidth Product	f_T	$V_{CE}=10\text{V}, I_C=50\text{mA}$		540		MHz
Output Capacitance	C_{ob}	$V_{CB}=10\text{V}, f=1\text{MHz}$		3.3		pF
Collector-to-Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C=200\text{mA}, I_B=10\text{mA}$		85	190	mV
Base-to-Emitter Saturation Voltage	$V_{BE(sat)}$	$I_C=200\text{mA}, I_B=10\text{mA}$		0.9	1.2	V
Collector-to-Base Breakdown Voltage	$V_{(BR)CBO}$	$I_C=10\mu\text{A}, I_E=0\text{A}$	40			V
Collector-to-Emitter Breakdown Voltage	$V_{(BR)CEO}$	$I_C=1\text{mA}, R_{BE}=\infty$	30			V
Emitter-to-Base Breakdown Voltage	$V_{(BR)EBO}$	$I_E=10\mu\text{A}, I_C=0\text{A}$	5			V
Turn-ON Time	t_{on}	See specified Test Circuit.		35		ns
Storage Time	t_{stg}			255		ns
Fall Time	t_f			40		ns

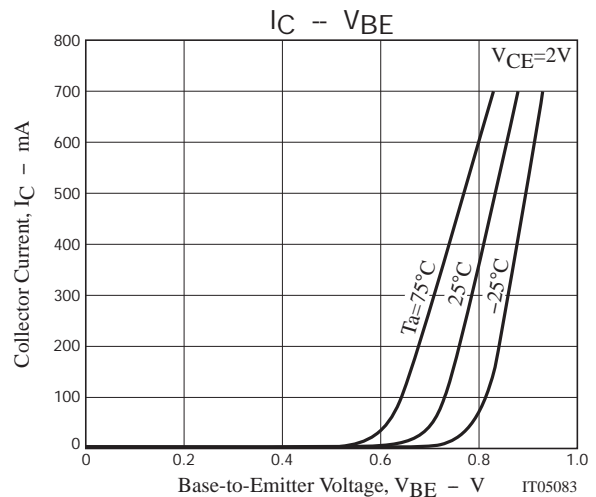
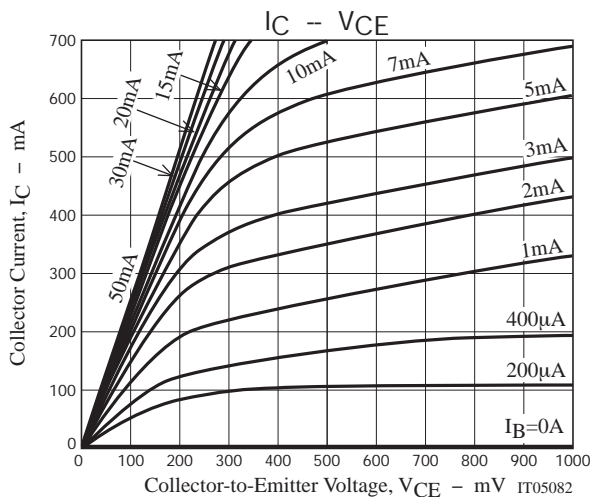
Switching Time Test Circuit



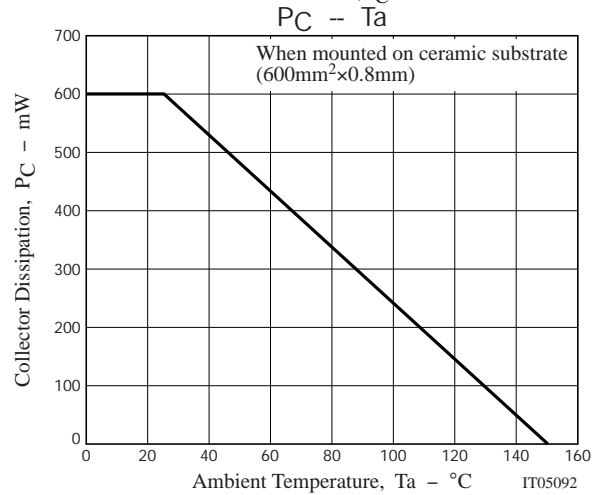
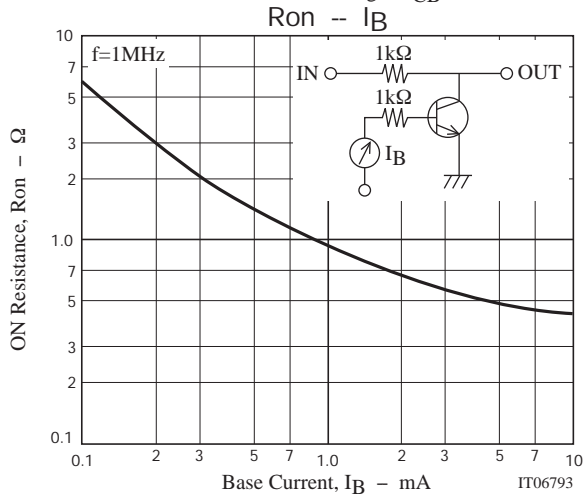
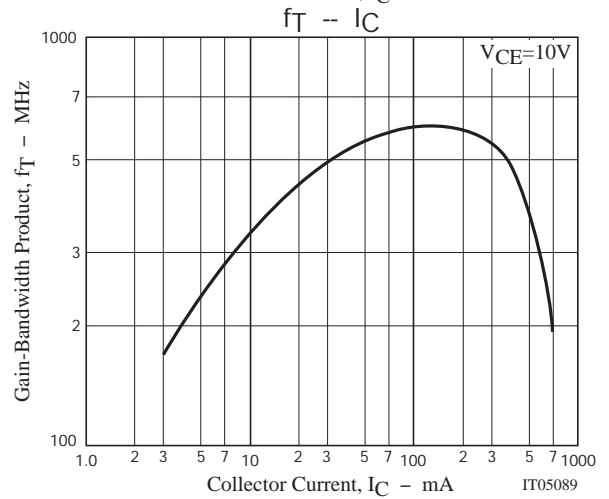
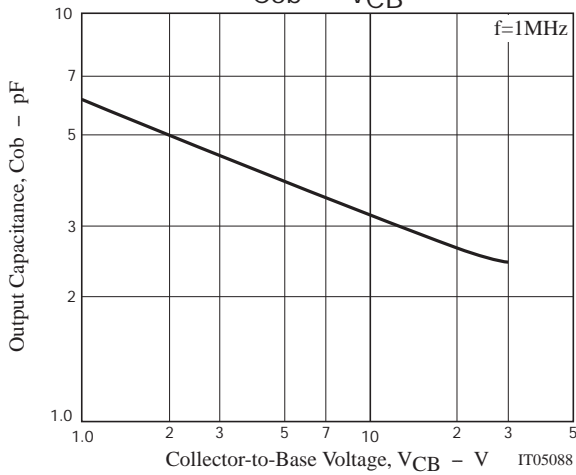
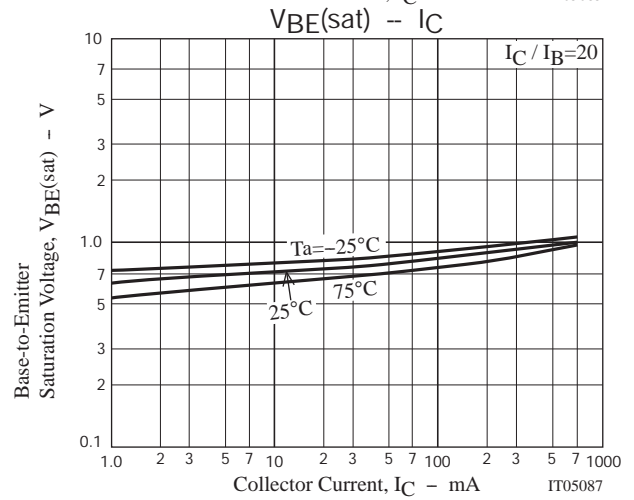
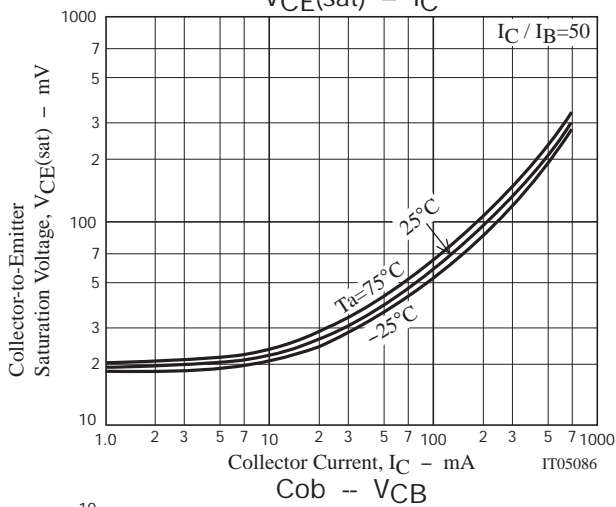
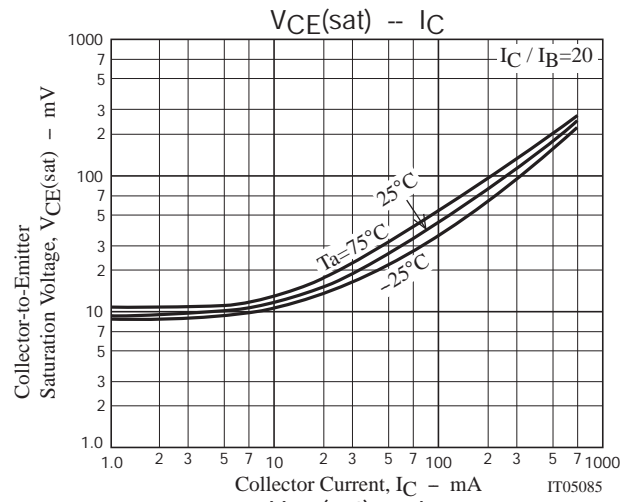
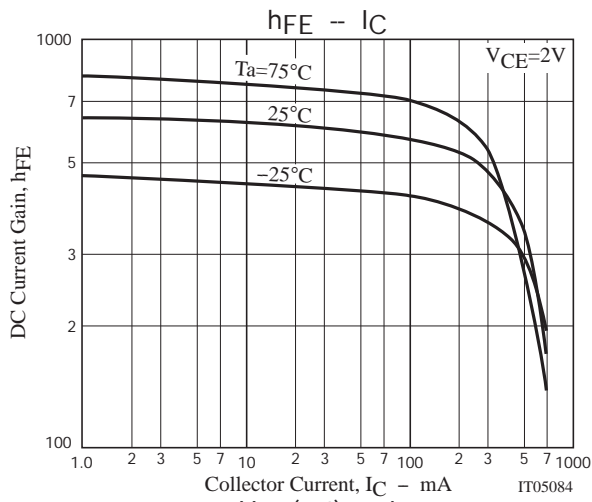
$$I_C = 20I_{B1} = -20I_{B2} = 300\text{mA}$$

Ordering Information

Device	Package	Shipping	memo
30C02MH-TL-E	MCPH3	3,000pcs./reel	Pb Free
30C02MH-TL-H	MCPH3	3,000pcs./reel	Pb Free and Halogen Free



30C02MH



Embossed Taping Specification

30C02MH-TL-E, 30C02MH-TL-H

1. Packing Format

Package Name	Carrier Tape Type	Maximum Number of devices contained (pcs)			Packing format	
		Reel	Inner box	Outer box	Inner BOX (C-1)	Outer BOX (A-7)
MCPH3	MCPH3	3,000	15,000	90,000	5 reels contained Dimensions:mm (external) 183×72×185	6 inner boxes contained Dimensions:mm (external) 440×195×210

Reel label, Inner box label
(unit: mm)

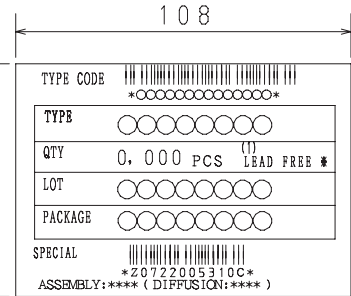
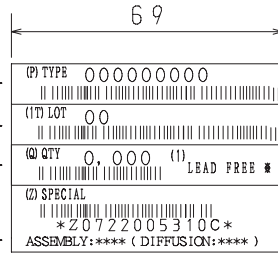
Outer box label
It is a label at the time of factory shipments.
The form of a label may change in physical distribution process.

Packing method



Type No.
LOT No.
Quantity
Origin

Reel label



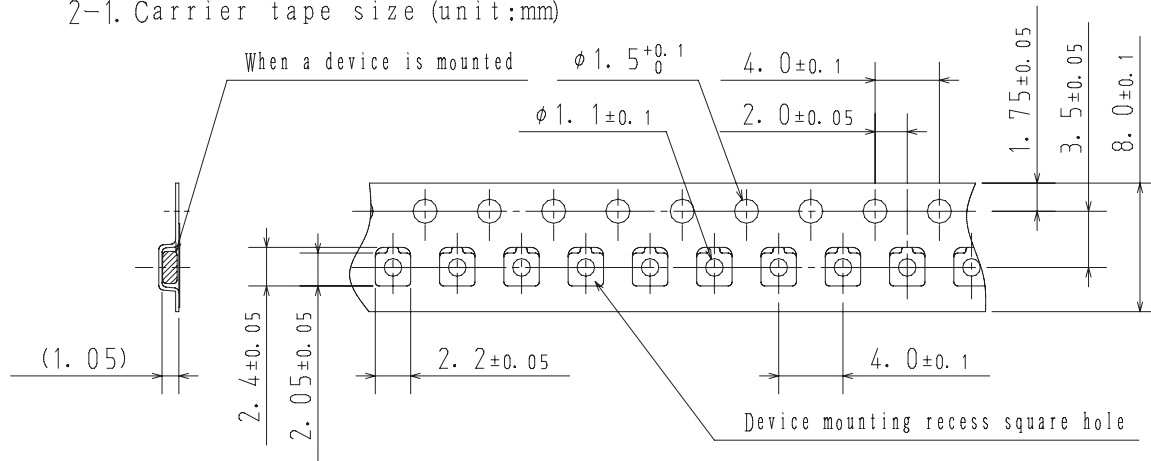
NOTE (1)

The LEAD FREE * description shows that the surface treatment of the terminal is lead free.

Label	JEITA Phase
LEAD FREE 3	JEITA Phase 3A
LEAD FREE 4	JEITA Phase 3

2. Taping configuration

2-1. Carrier tape size (unit:mm)



2-2. Device placement direction



Those with pin 1 index on the feed hole side.....TL

30C02MH

Outline Drawing

30C02MH-TL-E, 30C02MH-TL-H



Land Pattern Example



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